The RF Line NPN Silicon RF Power Transistor

. . . designed primarily for wideband large—signal output amplifier stages in the 100 to 500 MHz frequency range.

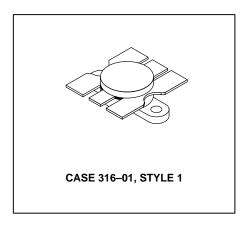
- Guaranteed Performance @ 400 MHz, 28 Vdc Output Power = 40 Watts Minimum Gain = 9.0 dB
- Built-In Matching Network for Broadband Operation
- 100% Tested for Load Mismatch at all Phase Angles with 30:1 VSWR
- · Gold Metallization System for High Reliability Applications

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCEO	33	Vdc
Collector-Base Voltage	V _{CBO}	60	Vdc
Emitter–Base Voltage	V _{EBO}	4.0	Vdc
Collector Current — Continuous — Peak	lC	4.5 6.0	Adc
Total Device Dissipation @ T _C = 25°C (1) Derate above 25°C	PD	110 0.63	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

MRF326

40 W, 225 to 400 MHz CONTROLLED "Q" BROADBAND RF POWER TRANSISTOR NPN SILICON



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.6	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u> </u>				
Collector–Emitter Breakdown Voltage (I _C = 40 mAdc, I _B = 0)	V(BR)CEO	33	_	_	Vdc
Collector–Emitter Breakdown Voltage (I _C = 40 mAdc, V _{BE} = 0)	V(BR)CES	60	_	_	Vdc
Emitter–Base Breakdown Voltage (I _E = 4.0 mAdc, I _C = 0)	V(BR)EBO	4.0	_	_	Vdc
Collector–Base Breakdown Voltage (I _C = 40 mAdc, I _E = 0)	V(BR)CBO	60	_	_	Vdc
Collector Cutoff Current (V _{CB} = 30 Vdc, I _E = 0)	ІСВО	_	_	4.0	mAdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 2.0 Adc, V _{CE} = 5.0 Vdc)	hFE	20	50	80	_
YNAMIC CHARACTERISTICS					
Output Capacitance (V _{CB} = 28 Vdc, I _E = 0, f = 1.0 MHz)	C _{ob}	_	45	60	pF

NOTE:

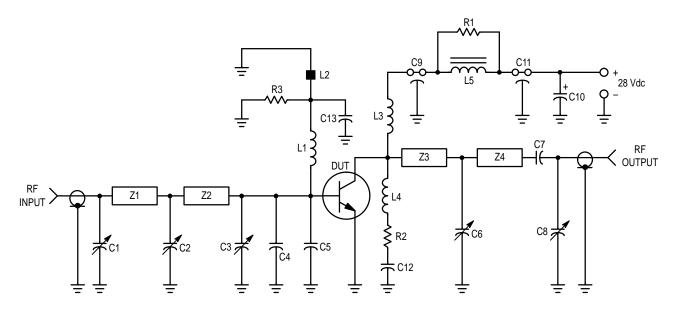
(continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.



ELECTRICAL CHARACTERISTICS — **continued** ($T_C = 25$ °C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
FUNCTIONAL TESTS (Figure 1)		•		•	•
Common–Emitter Amplifier Power Gain (V _{CC} = 28 Vdc, P _{out} = 40 W, f = 400 MHz, I _C Max = 2.85 Adc)	GPE	9.0	11	_	dB
Collector Efficiency (V _{CC} = 28 Vdc, P _{out} = 40 W, f = 400 MHz, I _C Max = 2.85 Adc)	η	50	_	_	%
Load Mismatch (V _{CC} = 28 Vdc, P _{out} = 40 W CW, f = 400 MHz, VSWR = 30:1 All Phase Angles)	Ψ	No Degradation in Output Power			



C1 — 1.0-10 pF Johanson, Capacitor (JMC 5201)

C2, C3, C6, C8 — 1.0-20 pF Johanson Capacitor

C4, C5 — 36 pF ATC "B" Style Chip Capacitor

C7, C9, C13 — 100 pF UNELCO Capacitor C11 — 680 pF Feedthru

 $C10 - 1.0 \,\mu\text{F}$ 50 V Tantalum

C12 — 0.1 µF Erie Redcap

L1 — 8 Turns #26 AWG Enameled, 1/16" ID Closewound

L2, L5 — Ferroxcube VK200-19/4B Ferrite Choke

L3 — 8 Turns #20 AWG Enameled, 1/4" ID Closewound

L4 — 4 Turns #26 AWG 0.1" ID

R1 — 10 Ohm 2.0 W Carbon

R2, R3 — 10 Ohm 1.0 W Carbon

Z1 — Microstrip 0.19" W x 1.28" L

Z2 — Microstrip 0.28" W x 1.0" L

Z3 — Microstrip 0.31" W x 1.0" L

Z4 — Microstrip 0.31" W x 0.9" L

Board — Glass Teflon $\varepsilon_r = 2.56 t = 0.062''$

Input/Output Connectors — Type N UG58 A/U

Figure 1. 400 MHz Test Amplifier

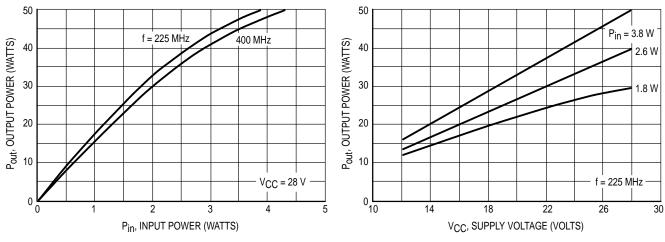


Figure 2. Output Power versus Input Power

Figure 3. Output Power versus Supply Voltage

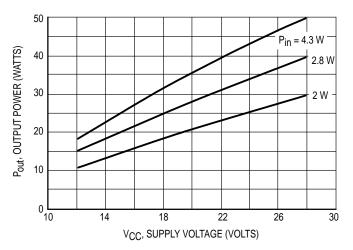
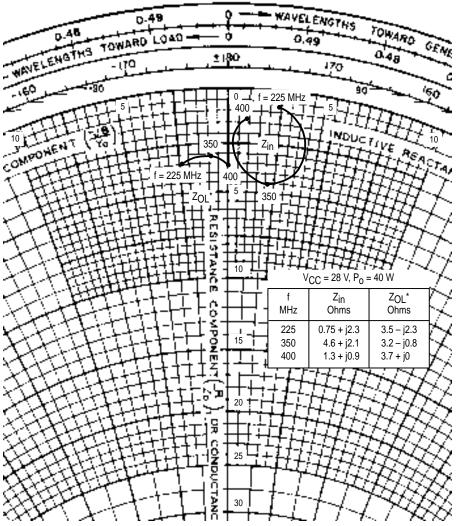


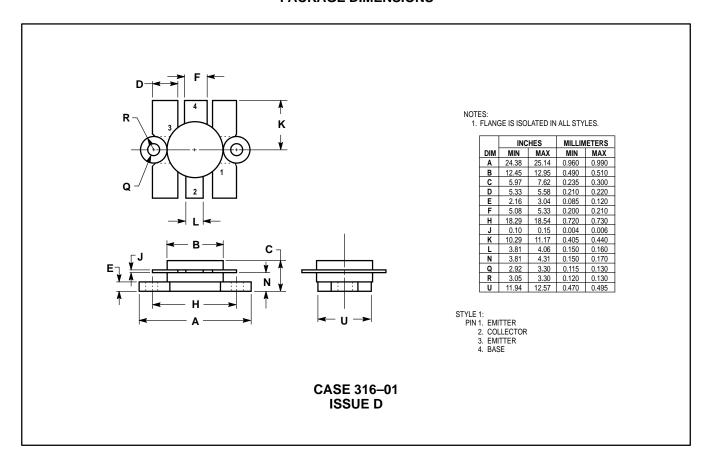
Figure 4. Output Power versus Supply Voltage f = 400 MHz



Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 5. Series Equivalent Input-Output Impedance

PACKAGE DIMENSIONS



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